

## WG50N65DHW



IGBT

**Product data sheet** 

#### **1. General description**

High speed IGBT with anti-parallel diode in TO247 package.



#### 2. Features and benefits

- High speed with low switching losses
- · Fast and soft recovery anti-parallel diode
- Positive V<sub>CE(sat)</sub> temperature coefficient
- Trench gate field-stop technology
- · Halogen Free package and Pb-free lead finish, RoHS compliant
- · Low thermal resistance
- · Qualified according to JEDEC, Meets UL94V0 Flammability requirement

#### 3. Applications

- Power Factor Correction
- Welding Converter
- Solar Inverter
- Industrial Inverter
- UPS

#### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter			Value			Unit
$V_{CE}$	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$			650			
I <sub>c</sub>	DC collector current, limited by $T_{j(max)}$ T <sub>c</sub> = 100 °C			50			А
Symbol	Parameter Conditions			Min	Тур	Мах	Unit
Static cha	racteristics						
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	$V_{GE}$ = 15 V; I <sub>C</sub> = 50 A; T <sub>j</sub> = 25 °C		-	1.65	2	V

### 5. Pinning information

Pin	inning infor Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		۹C
2	С	collector		
3	E	emitter		
mb	С	mounting base; connected to collector		G E sym200

### 6. Ordering information

Table 3. Ordering information							
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
WG50N65DHW	TO247	WG50N65DHWQ	Tube	30	SOT429	25-Mar-2013	

#### 7. Marking

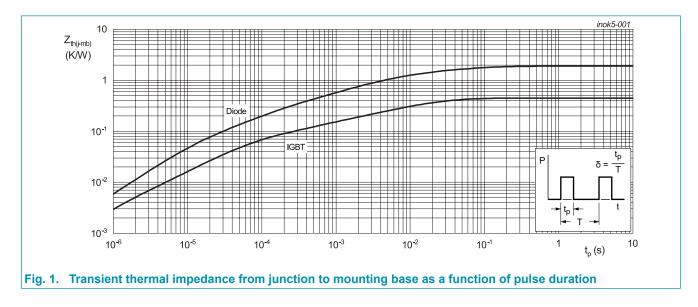
Table 4. Marking codes		
Type number	Marking codes	
WG50N65DHW	WG50N	
	65DHW	

### 8. Limiting values

Symbol	Parameter	Value	Unit
V <sub>CE</sub>	Collector-emitter voltage, $T_j \ge 25 \degree C$	650	V
I <sub>C</sub>	DC collector current, limited by $T_{j(max)}$ T <sub>c</sub> = 25 °C T <sub>c</sub> = 100 °C	91 50	A
I <sub>C(puls)</sub>	Pulsed collector current, $t_p$ limited by $T_{j(max)}$	200	А
-	Turn off safe operating area $V_{CE} \le 600 \text{ V}, T_j \le 150 \text{ °C}, t_p = 1 \ \mu\text{s}$	200	A
I <sub>F</sub>	Diode forward current, limited by $T_{j(max)}$ $T_c = 25 \text{ °C}$ $T_c = 100 \text{ °C}$	100 50	A
$V_{GE}$	Gate-emitter voltage Transient Gate-emitter voltage ( $t_p \le 10$ us, D < 0.010)	±20	V
P <sub>tot</sub>	Power dissipation $T_c = 25 \ ^{\circ}C$ Power dissipation $T_c = 100 \ ^{\circ}C$	278 111	W
T <sub>stg</sub>	Storage temperature	-55 to 150	°C
Tj	Operating junction temperature	-55 to 150	°C
-	Peak soldering temperture	260	°C
M	Mounting Torque with washer	0.55	Nm

### 9. Thermal characteristics

Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	IGBT thermal resistance from junction to mounting base		-	-	0.45	K/W
$R_{th(j-mb)}$	Diode thermal resistance from junction to mounting base		-	-	1.9	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient		-	40	-	K/W

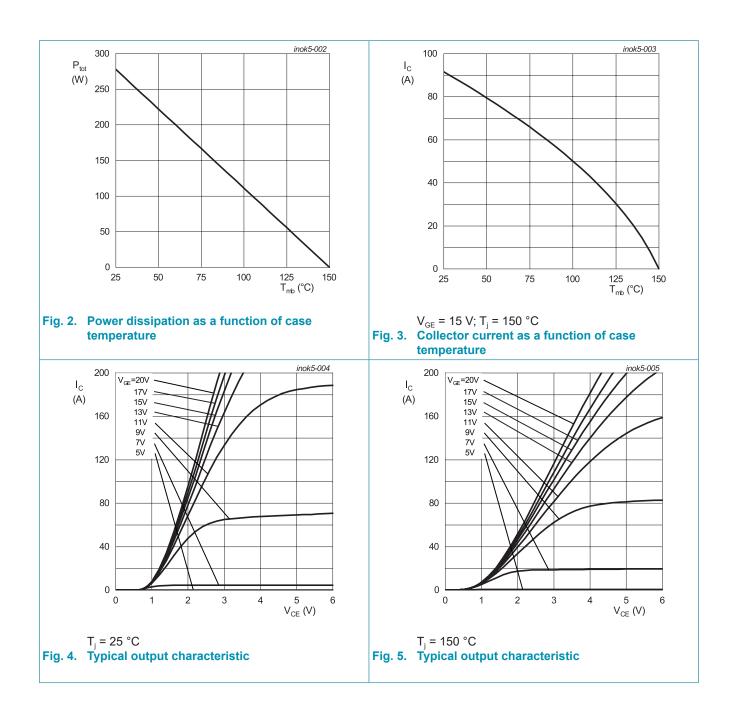


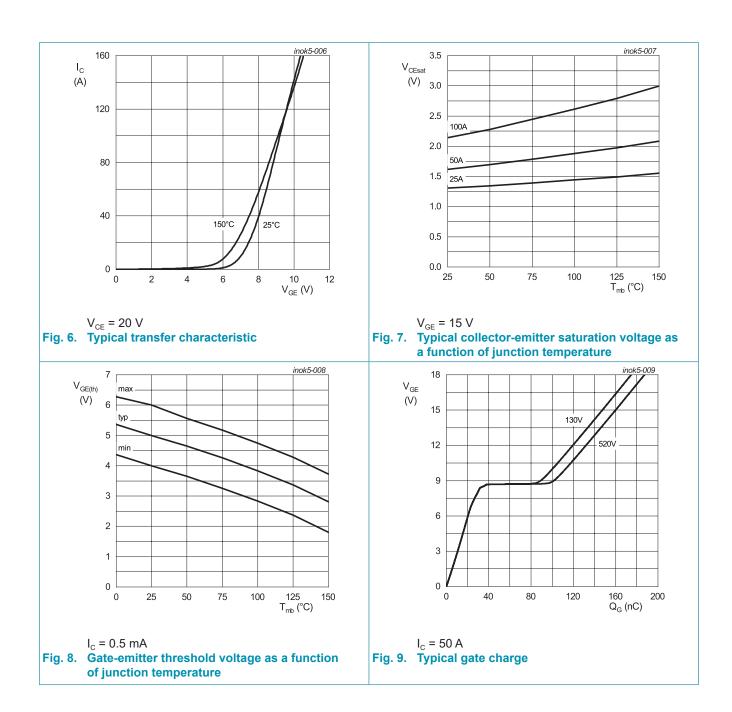
### **10. Characteristics**

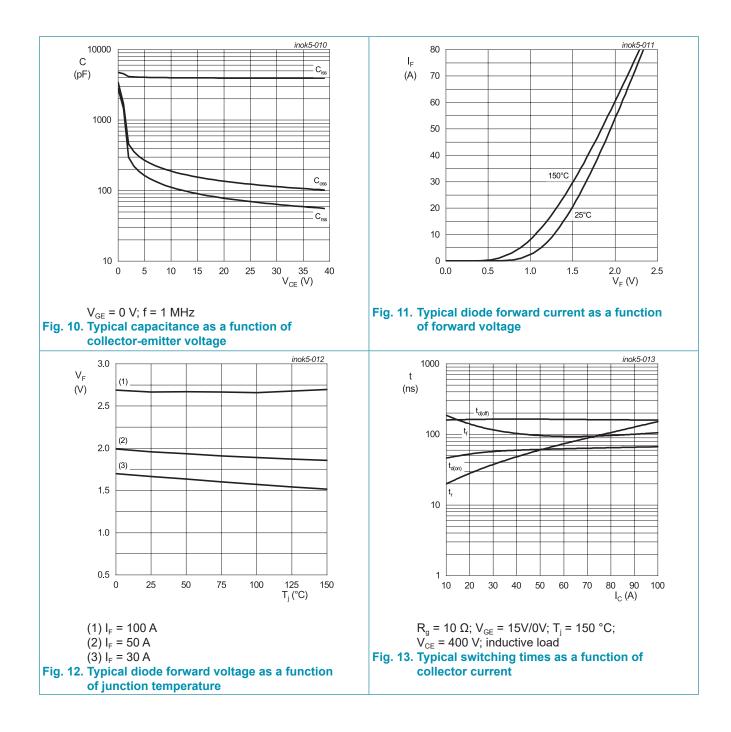
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
$BV_{CES}$	Collector-emitter breakdown voltage	V <sub>GE</sub> = 0 V; I <sub>C</sub> = 0.2 mA	650	-	-	V
CE(sat)	Collector-emitter saturation	$V_{GE}$ = 15 V; $I_{C}$ = 50 A; $T_{j}$ = 25 °C	-	1.65	2	V
	voltage	V <sub>GE</sub> = 15 V; I <sub>C</sub> = 50 A; T <sub>j</sub> = 150 °C	-	2.05	-	V
V <sub>F</sub> Diode forward vo	Diode forward voltage	$V_{GE}$ = 0 V; I <sub>F</sub> = 30 A; T <sub>j</sub> = 25 °C	-	1.7	2.4	V
		$V_{GE}$ = 0 V; I <sub>F</sub> = 30 A; T <sub>j</sub> = 150 °C	-	1.55	-	V
$V_{\text{GE(th)}}$	Gate-emitter threhold voltage	$I_{c}$ = 0.25 mA; $V_{ce}$ = $V_{ge}$	4	5	6	V
I <sub>CES</sub>	Zero gate voltage collector current	V <sub>CE</sub> = 650 V; V <sub>GE</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	10	uA
		V <sub>CE</sub> = 650 V; V <sub>GE</sub> = 0 V; T <sub>j</sub> = 150 °C	-	-	2	mA
<b>g</b> <sub>fs</sub>	Transconductance	V <sub>CE</sub> = 20 V; I <sub>C</sub> = 50 A	-	50	-	S
Dynamic	characteristics					
C <sub>ies</sub>	Input capacitance	V <sub>CE</sub> = 25 V; V <sub>GE</sub> = 0V; f = 1 MHz;	-	3800	-	pF
C <sub>oes</sub>	Output capacitance	T <sub>j</sub> = 25 °C	-	130	-	pF
C <sub>res</sub>	Reverse transfer capacitance	-	-	70	-	pF
Q <sub>G</sub>	Gate charge	V <sub>CC</sub> = 520 V; I <sub>C</sub> = 50 A; V <sub>GE</sub> = 15 V; T <sub>i</sub> = 25 °C	-	160	-	nC

#### **11. Switching Characteristics**

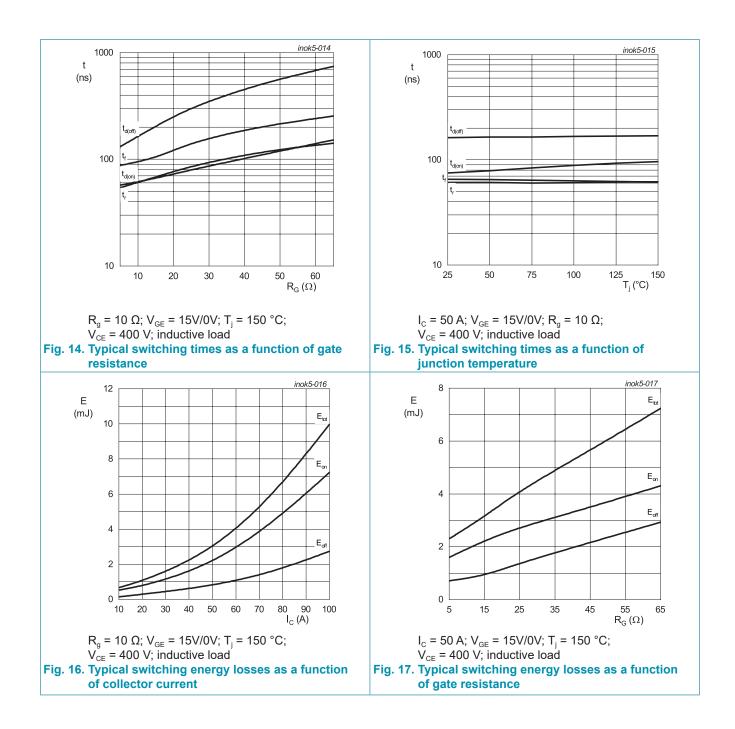
	witching Characteristics, Ir			Turn	Mary	Link
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
IGBT cha	racteristics	1	 	1	1	1
t <sub>d(on)</sub>	Turn-on delay time	$T_j = 25 \ ^{\circ}C;$	-	66	-	nS
t <sub>r</sub>	Rise time	$V_{cc} = 400$ V; I <sub>c</sub> = 50 A; V <sub>GE</sub> = 15V / 0V; R <sub>G</sub> = 10 ohm; Energy losses include	-	61	-	nS
$t_{\rm d(off)}$	Turn-off delay time	"tail" and diode reverse recovery	-	163	-	nS
t <sub>f</sub>	Fall time		-	76	-	nS
Eon	Turn-on energy		-	1.7	-	mJ
$E_{off}$	Turn-off energy		-	0.6	-	mJ
E <sub>ts</sub>	Total switching energy		-	2.3	-	mJ
t <sub>d(on)</sub>	Turn-on delay time	$T_j = 150 \text{°C};$	-	62	-	nS
t <sub>r</sub>	Rise time	$V_{CC} = 400 \text{ V}; I_C = 50 \text{ A}; V_{GE} = 15 \text{ V} / 0 \text{ V};$ $R_G = 10 \text{ ohm}; \text{ Energy losses include}$ "tail" and diode reverse recovery	-	61	-	nS
$t_{\rm d(off)}$	Turn-off delay time		-	170	-	nS
t <sub>f</sub>	Fall time		-	95	-	nS
E <sub>on</sub>	Turn-on energy		-	1.9	-	mJ
$E_{off}$	Turn-off energy		-	0.8	-	mJ
E <sub>ts</sub>	Total switching energy		-	2.7	-	mJ
Diode cha	aracteristics	·				
t <sub>rr</sub>	Reverse recovery time	T <sub>j</sub> = 25 °C;	-	105	-	nS
Qr	Reverse recovery charge	$V_{R} = 400 \text{ V}; I_{F} = 30 \text{ A}; dI_{F}/dt = 500 \text{ A/us}$	-	570	-	nC
I <sub>RM</sub>	Reverse recovery peak current		-	11	-	A
t <sub>rr</sub>	Reverse recovery time	$T_j = 150 \text{°C};$	-	127	-	nS
Qr	Reverse recovery charge	$\dot{V_R}$ = 400 V; I <sub>F</sub> = 30 A; dI <sub>F</sub> /dt = 500A/us	-	1265	-	nC
I <sub>RM</sub>	Reverse recovery peak current		-	17	-	Α





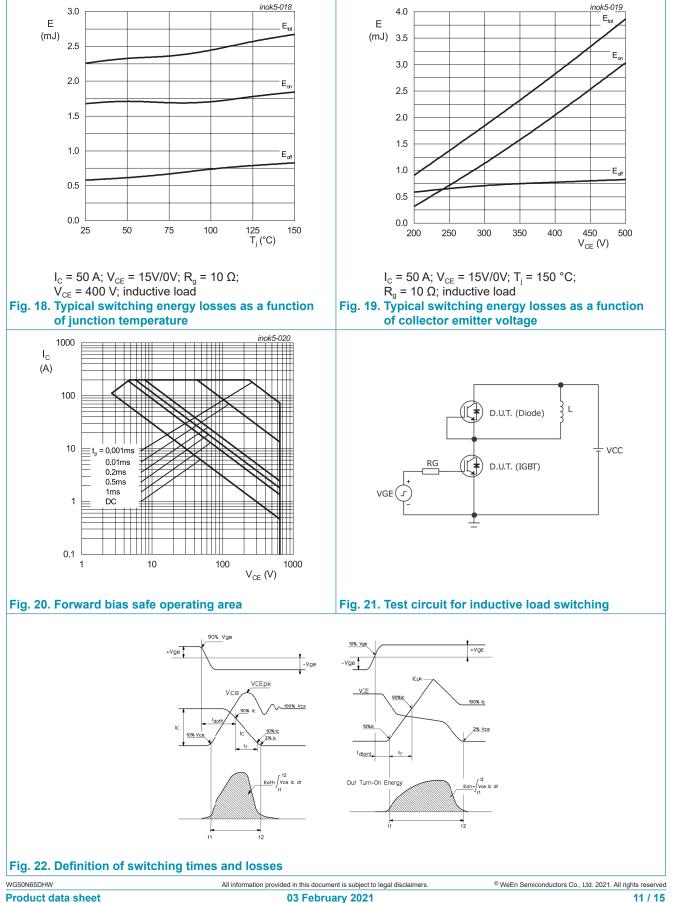


WG50N65DHW



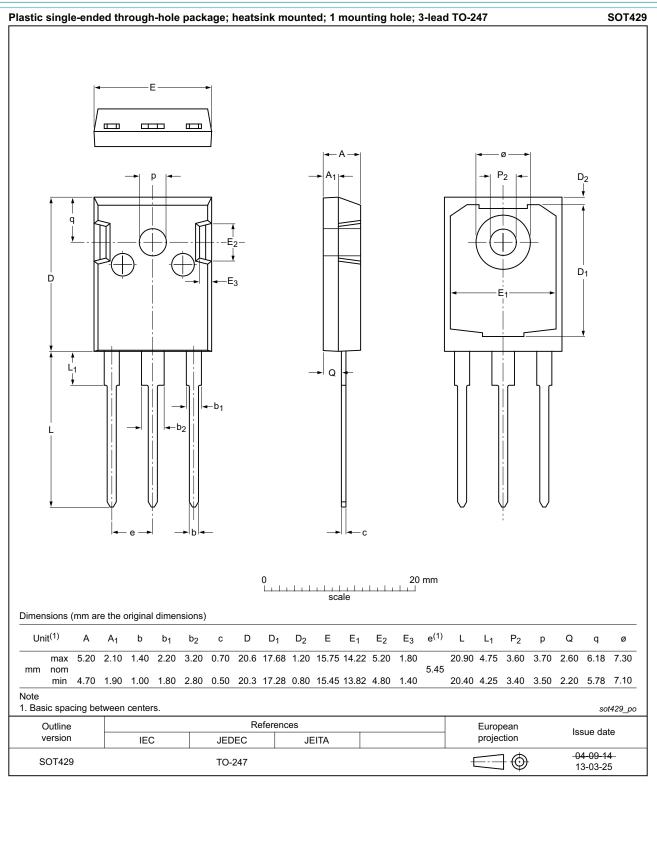
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WG50N65DHW **IGBT** 





#### 12. Package outline



# WG50N65DHW

### 13. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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